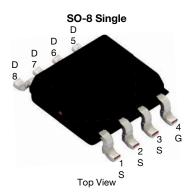
# Vishay Siliconix

# N-Channel 20 V (D-S) MOSFET



PRODUCT SUMMARY					
V <sub>DS</sub> (V)	20				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.006				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.007				
Q <sub>g</sub> typ. (nC)	27.5				
I <sub>D</sub> (A) a, e	20				
Configuration	Single				

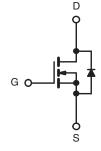
#### **FEATURES**

- TrenchFET® power MOSFET
- 100 % R<sub>g</sub> and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



### **APPLICATIONS**

- Low side MOSFET for synchronous buck
  - Game machine
  - PC



N-Channel MOSFET

ORDERING INFORMATION				
Package	SO-8			
Lead (Pb)-free	Si4114DY-T1-E3			
Lead (Pb)-free and halogen-free	Si4114DY-T1-GE3			

ABSOLUTE MAXIMUM RATING	<b>iS</b> (T <sub>A</sub> = 25 °C, u	ınless otherw	vise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	20	V	
Gate-source voltage		$V_{GS}$	± 16	v	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		20 <sup>e</sup>		
	T <sub>C</sub> = 70 °C	1 , [	18.2		
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	15.2 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		12.1 <sup>b, c</sup>	^	
Pulsed drain current		I <sub>DM</sub>	50	A	
Canting and a support	T <sub>C</sub> = 25 °C	- I <sub>S</sub>	5.1		
Continuous source-drain diode current	T <sub>A</sub> = 25 °C		2.2 <sup>b, c</sup>		
Single pulse avalanche current		I <sub>AS</sub>	30		
Avalanche energy	L = 0.1 mH	E <sub>AS</sub>	45	mJ	
Maximum power dissipation	T <sub>C</sub> = 25 °C		5.7		
	T <sub>C</sub> = 70 °C	]	3.6	w	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 <sup>b, c</sup>	VV	
	T <sub>A</sub> = 70 °C	1	1.6 <sup>b, c</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT			
Maximum junction-to-ambient b, d	t ≤ 10 s	R <sub>thJA</sub>	39	50	°C/W		
Maximum junction-to-foot (drain)	Steady state	R <sub>thJF</sub>	18	22	C/W		

#### Notes

- a. Based on T<sub>C</sub> = 25 °C
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10.9
- d. Maximum under steady state conditions is 85 °C/W
- e. Package limited



# Vishay Siliconix

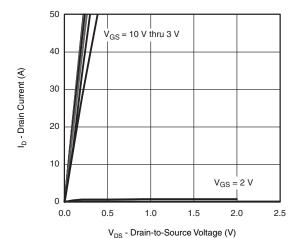
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static				•			
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	20	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	J 050 ·· A	-	19	-	\//90	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = 250 \mu A$	-	-5.3	-	mV/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_{D} = 250 \mu A$	1	-	2.1	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 16 \text{ V}$	-	-	± 100	nA	
Zava sata waltana disaha awasat		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	uА	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$	-	-	10		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30	-	-	Α	
Duning	_	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A	-	0.0049	0.0060	Ω	
Drain-source on-state resistance a	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 7 \text{ A}$	-	0.0056	0.0070		
Forward transconductance a	9 <sub>fs</sub>	$V_{DS} = 10 \text{ V}, I_D = 10 \text{ A}$	-	55	-	S	
Dynamic <sup>b</sup>				•			
Input capacitance	C <sub>iss</sub>		-	3700	-	pF	
Output capacitance	C <sub>oss</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	745	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	315	-		
Total gate charge	Q <sub>g</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	-	62	95	nC	
			-	27.5	42		
Gate-source charge	Q <sub>qs</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$	-	8	-		
Gate-drain charge	Q <sub>gd</sub>		-	6	-		
Gate resistance	$R_g$	f = 1 MHz	0.15	0.7	1.4	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	30	55		
Rise time	t <sub>r</sub>	$V_{DD} = 10 \text{ V}, R_L = 2 \Omega$	-	13	25		
Turn-off delay time	t <sub>d(off)</sub>	$I_D\cong 5$ A, $V_{GEN}=4.5$ V, $R_g=1$ $\Omega$	-	60	100		
Fall time	t <sub>f</sub>		-	30	55		
Turn-on delay time	t <sub>d(on)</sub>		-	13	25	ns	
Rise time	t <sub>r</sub>	$V_{DD}$ = 10 V, $R_L$ = 2 $\Omega$	-	9	18		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 5 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	38	65		
Fall time	t <sub>f</sub>		-	8	16		
<b>Drain-Source Body Diode Characterist</b>	ics						
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	5.1	^	
Pulse diode forward current a	I <sub>SM</sub>		-	-	50	Α	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = 2 A	-	0.71	1.1	V	
Body diode reverse recovery time	t <sub>rr</sub>	-	-	26	50	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	16	30	nC	
Reverse recovery fall time	t <sub>a</sub>	$T_J = 25  ^{\circ}\text{C}$	-	13	-		
Reverse recovery rise time	t <sub>b</sub>		_	13	-	ns	

### Notes

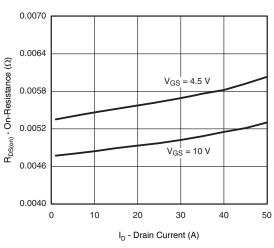
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

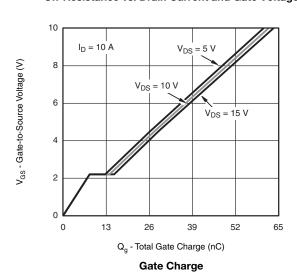


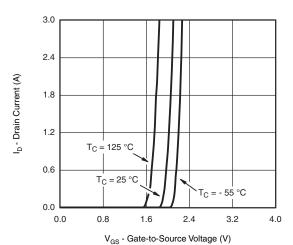


#### **Output Characteristics**

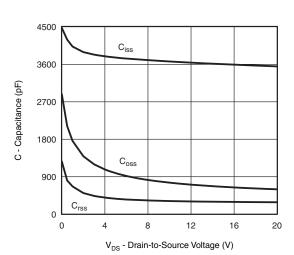


### On-Resistance vs. Drain Current and Gate Voltage

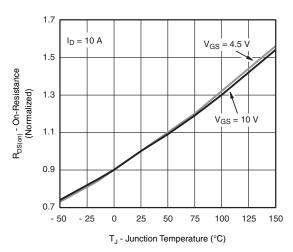




#### **Transfer Characteristics**

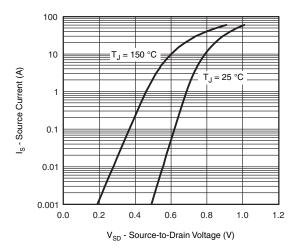


### Capacitance

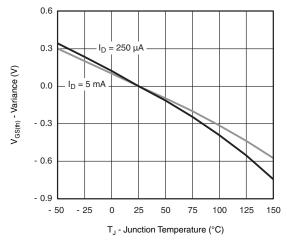


On-Resistance vs. Junction Temperature

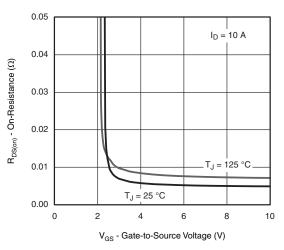




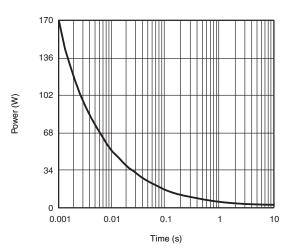
#### Source-Drain Diode Forward Voltage



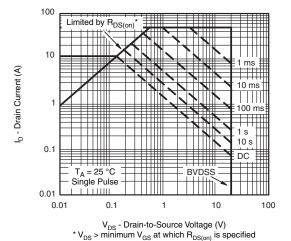
**Threshold Voltage** 



On-Resistance vs. Gate-to-Source Voltage



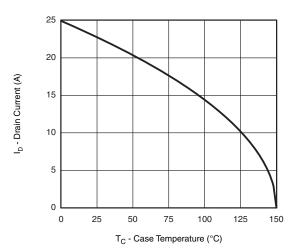
Single Pulse Power, Junction-to-Ambient



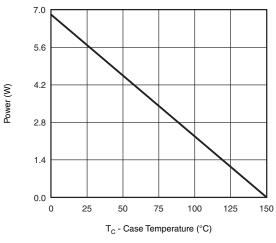
Safe Operating Area, Junction-to-Ambient

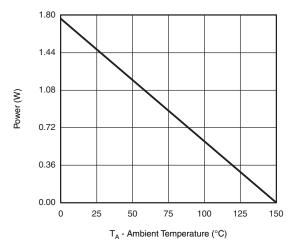
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#### Current Derating a





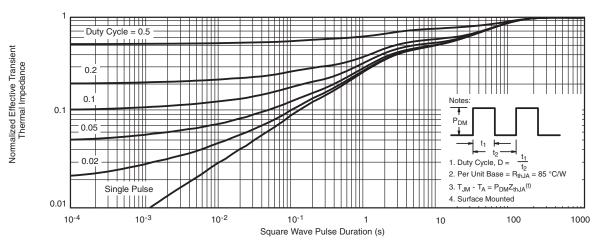
Power, Junction-to-Foot

Power, Junction-to-Ambient

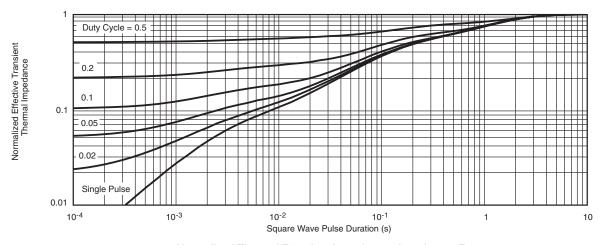
#### Notes

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?68394">www.vishay.com/ppg?68394</a>.



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INC	HES	
DIM	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
Е	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I. 11-Sep-06					

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



## **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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